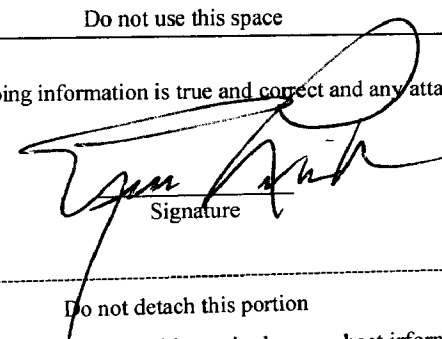




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5. Name and address of party to whom correspondence concerning document should be mailed:  Name: David A. Einhorn, Esq. Internal Address: ANDERSON, KILL & OLICK, P.C. Street Address: 1251 Avenue of the Americas 42nd Floor City: <u>NEW YORK</u> State: <u>N.Y.</u> Zip: <u>10020-1182</u>		6. Total number of applications and patents involved . . .  7. Total fee (37 CFR 3.41) . . . . . \$ <u>40.00</u>  _ Enclosed <input checked="" type="checkbox"/> Authorized to be charged to deposit account #503814	
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9. <u>Statement and signature.</u> To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.  Eugene Lieberstein REG. NO.: 24,645 Name of Person Signing   Signature  November 22, 2006 Date Total number of pages including cover sheet, attachments, and document: 2			
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# ASSIGNMENT

WHEREAS, WE, **Seung Koo SHIN**; **Sung Jun LIM**; and **Yongwook KIM**, ASSIGNORS, citizens of U.S.A., Republic of Korea and Republic of Korea, respectively, residing at **Gyosu Apt. 4-1501, Jigok-dong, Nam-gu, Pohang-si, Gyeongsangbuk-do 790-751, Korea**; **#981-72, Sajik-2-dong, Dongrae-gu, Busan 607-122, Korea**; and **Kukje Apt. 105, #388-1, Namsan-dong, Geumjeong-gu, Busan 609-340, Korea**, respectively, are the inventors of the invention in

## METHOD FOR PREPARING CORE/SHELL STRUCTURE NANOPARTICLES

for which We have executed an application for a Patent of the United States

- ☐ which is executed on ☐ even date herewith or ☐ \_\_\_\_\_ (date)  
☐ which is identified by Anderson Kill & Olick, P.C. docket no. \_\_\_\_\_  
☐ which was filed on \_\_\_\_\_, Serial No. \_\_\_\_\_

and WHEREAS, **POSTECH ACADEMY-INDUSTRY FOUNDATION** of **San 31, Hyoja-dong, Nam-gu, Pohang-si, Kyungsangbuk-do 790-784, Korea**, ASSIGNEE, is desirous of obtaining the entire right, title and interest in, to and under the said invention and the said application:

NOW, THEREFORE, in consideration of the sum of One Dollar (US\$1.00) to us in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, we, the said ASSIGNORS, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title and interest in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

AND WE HEREBY authorize and request the Commissioner of Patents and Trademarks of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant and agree that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, We hereunto set our hands and seals the day and year set opposite our respective signatures.

Date May 9, 2006

Seung Koo Shin L.S.

Date May 9, 2006

Sung Jun LIM L.S.

Date May 9, 2006

Yongwook Kim L.S.

PATENT

RECORDED: 11/22/2006

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